



Mini-Circuits

LTCC SMT

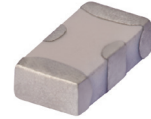
Band Pass Filter

BFCN-2840+

50Ω 2750 to 2930 MHz

THE BIG DEAL

- Good Rejection, 25 dB Typ.
- 1206 Surface Mount Footprint
- Power Handling: 1.5 Watts



Generic photo used for illustration purposes only

CASE STYLE: FV1206

+RoHS Compliant

The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Harmonic Rejection
- Transmitters / Receivers
- WiMAX

PRODUCT OVERVIEW

Mini-Circuits' BFCN-2840+ LTCC Band Pass Filter is constructed with multiple layers in order to achieve a miniature size and high repeatability of performance. Wrap-around terminations minimize variations in performance due to parasitics. Covering 180 MHz passband, these units offer low insertion loss and good rejection.

KEY FEATURES

Feature	Advantages
Small Size, 1206	Allows for high layout density of circuit boards, while minimizing the effects of parasitics
Wrap around termination	Provides excellent solderability and easy visual inspection capability.
LTCC construction	Provides a rugged package that is well suited for tough environments including high humidity and high temperature extremes.
Rugged Power handling	Handles up to 1.5 Watts in a small package.

REV. B
ECO-016659
BFCN-2840+
URJ
230202





LTCC SMT

Band Pass Filter

BFCN-2840+

ELECTRICAL SPECIFICATIONS^{1,2} AT 25°C

Parameter	F#	Frequency (MHz)	Min.	Typ.	Max.	Units
Passband	Center Frequency	—	—	2840	—	MHz
	Insertion Loss	F1-F2	2750 - 2930	—	7	dB
	Return Loss	F1-F2	2750 - 2930	12.7	—	dB
Stop Band, Lower	Rejection	DC-F3	DC - 1500	—	25	dB
		DC-F4	DC - 1550	20	—	
Stop Band, Upper	Rejection	F5-F6	4000 - 4050	—	—	dB
		F6-F7	4050 - 6000	25	—	

1. This component should not be used as a DC-block. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.

2. Measured on Mini-Circuits Characterization Test Board TB-270.

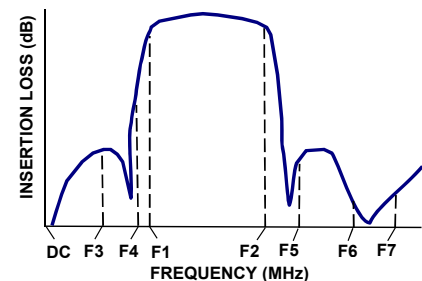
ABSOLUTE MAXIMUM RATINGS¹

Parameter	Ratings
Operating temperature	-55°C to 100°C
Storage temperature	-55°C to 100°C
RF Power Input ²	1.5W @25°C

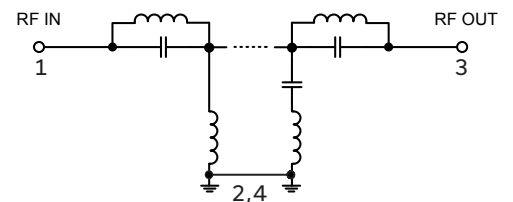
1. Permanent damage may occur if any of these limits are exceeded.

2. Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 0.25W at +100°C.

TYPICAL FREQUENCY RESPONSE



FUNCTIONAL DIAGRAM





Mini-Circuits®

LTCC SMT

Band Pass Filter

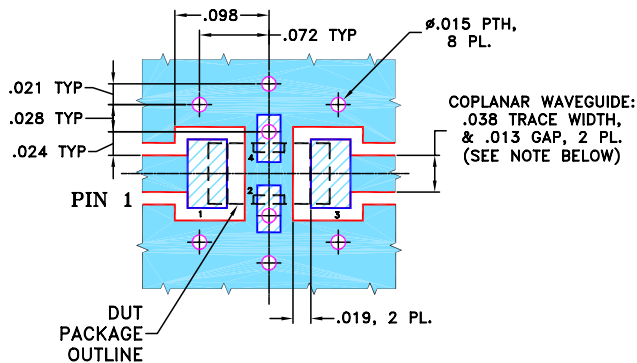
BFCN-2840+

PAD CONNECTIONS

RF IN	1
RF OUT	3
GROUND	2,4

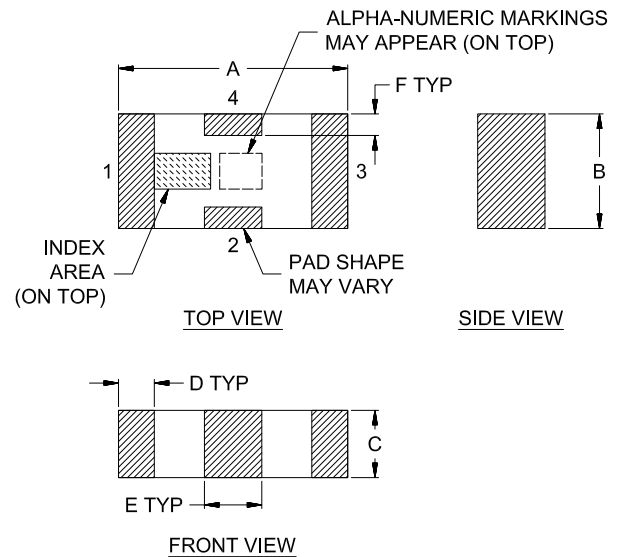
PRODUCT MARKING: RY

DEMO BOARD MCL P/N: TB-270
SUGGESTED PCB LAYOUT (PL-137)



- NOTES:**
1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH THICKNESS .020" $\pm$.0015".
 COPPER: 1/2 OZ. EACH SIDE.
 FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
-  DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
 DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

OUTLINE DRAWING



OUTLINE DIMENSIONS (Inches) mm

A	B	C	D	E	F	Wt.
.126	.063	.037	.020	.032	.009	grams
3.20	1.60	0.94	0.51	0.81	0.23	.020



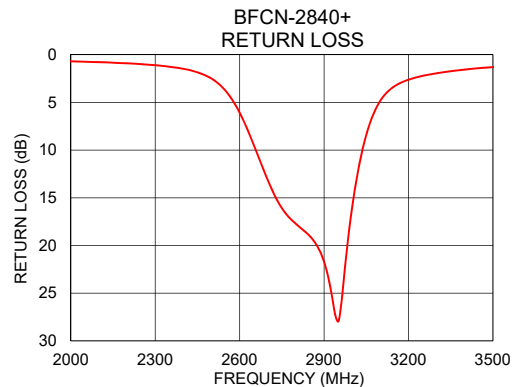
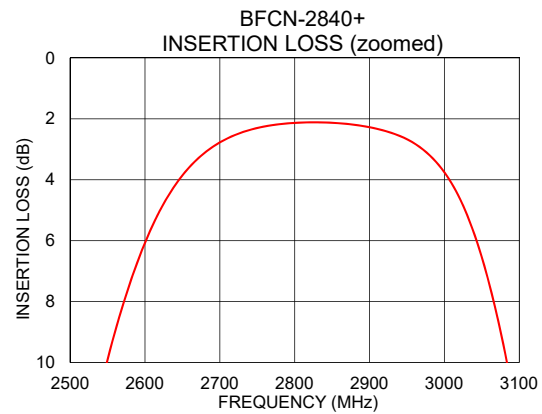
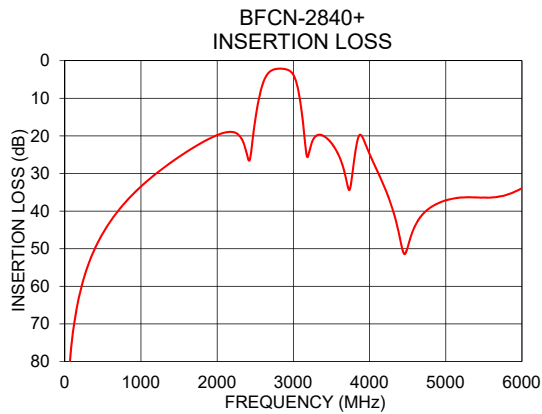
LTCC SMT

Band Pass Filter

BFCN-2840+

TYPICAL PERFORMANCE DATA AT 25°C

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)
50	84.00	0.13
1025	32.99	0.30
1500	25.57	0.38
1550	24.89	0.40
2666	3.41	10.65
2750	2.30	16.08
2795	2.14	17.59
2840	2.12	18.74
2903	2.29	21.98
2930	2.47	25.66
3037	5.58	9.88
3144	19.86	3.42
3679	30.28	1.01
4000	24.80	0.74
4050	27.06	0.68
6000	33.85	0.81



NOTES

- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



Ceramic Band Pass Filter

BFCN-2840+

Typical Performance Data

FREQ. (MHz)	INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	OUTPUT RETURN LOSS (dB)
	@ +25° C	@ +25° C	@ +25° C
50	84.86	0.07	0.00
60	81.54	0.08	0.00
70	78.85	0.08	0.00
80	76.60	0.09	0.01
90	75.10	0.10	0.01
100	73.09	0.10	0.01
200	61.16	0.15	0.02
300	54.23	0.17	0.04
400	49.24	0.20	0.06
500	45.37	0.21	0.08
600	42.16	0.23	0.11
700	39.45	0.24	0.14
800	37.08	0.26	0.17
900	35.02	0.27	0.20
1000	33.17	0.28	0.23
1100	31.46	0.29	0.26
1200	29.87	0.30	0.29
1300	28.33	0.31	0.31
1400	26.92	0.32	0.33
1500	25.64	0.33	0.35
1550	25.02	0.34	0.36
1600	24.37	0.35	0.36
1700	23.16	0.37	0.37
1800	22.05	0.40	0.39
1900	21.09	0.45	0.42
2000	20.26	0.51	0.45
2100	19.56	0.59	0.51
2200	19.25	0.69	0.59
2300	20.04	0.85	0.74
2400	24.55	1.12	1.01
2500	20.08	1.84	1.73
2570	10.64	3.35	3.18
2650	4.83	7.76	7.12
2800	2.32	16.38	13.05
2840	2.26	14.49	11.90
2900	2.55	11.44	9.42
2930	2.71	10.24	8.12
3070	8.96	6.48	2.72
3130	16.52	4.85	1.48
3190	20.25	3.51	1.08
3200	18.93	3.33	1.05
3300	14.43	2.22	0.94
3400	14.34	1.69	0.86
3500	15.47	1.40	0.82
3600	17.23	1.22	0.82
3700	19.29	1.11	0.91
3800	21.52	1.03	1.30
3900	24.97	0.97	3.91
4000	28.82	0.92	7.02
4500	36.06	0.79	0.65
5000	33.47	0.69	0.58
5500	30.78	0.69	0.66
6000	29.75	0.75	0.77

REV. X1

BFCN-2840+

090921

Page 1 of 1



IF/RF MICROWAVE COMPONENTS • ISO 9001 ISO 14001 AS9100 CERTIFIED RoHS compliant

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

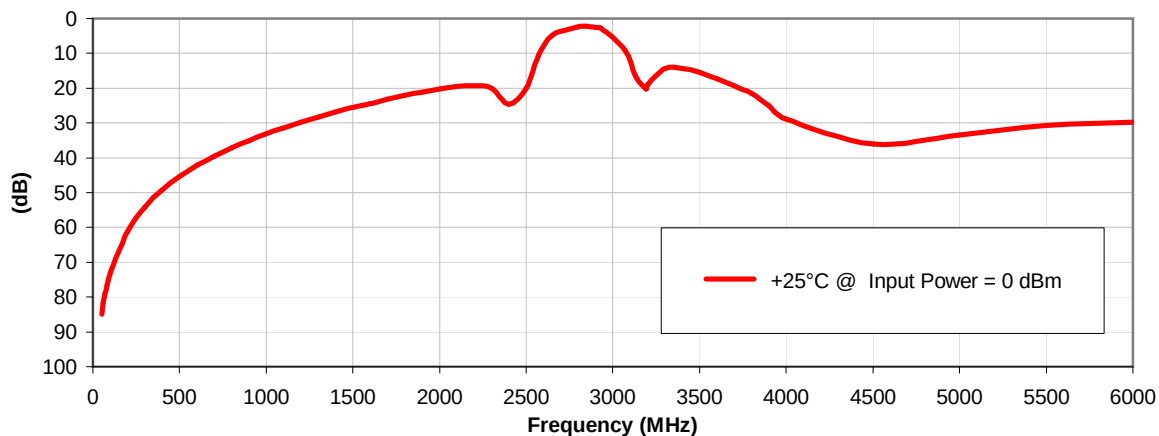


The Design Engineers Search Engine finds the model you need, Instantly • For detailed performance specs & shopping online see

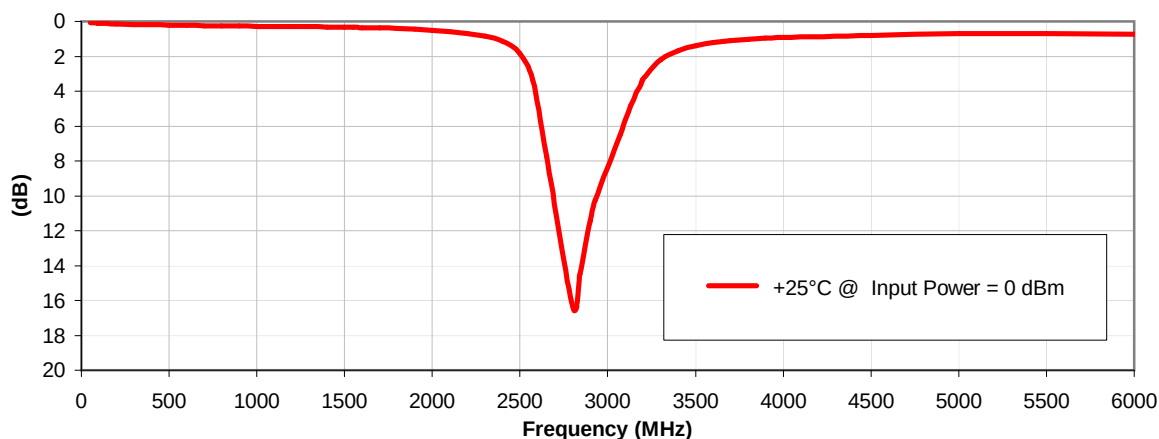


Typical Performance Curves

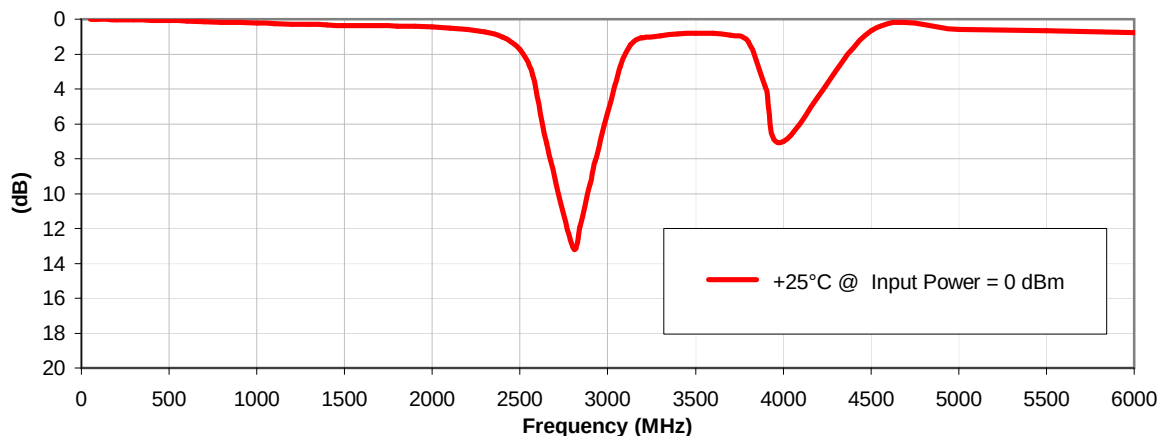
INSERTION LOSS vs. TEMPERATURE



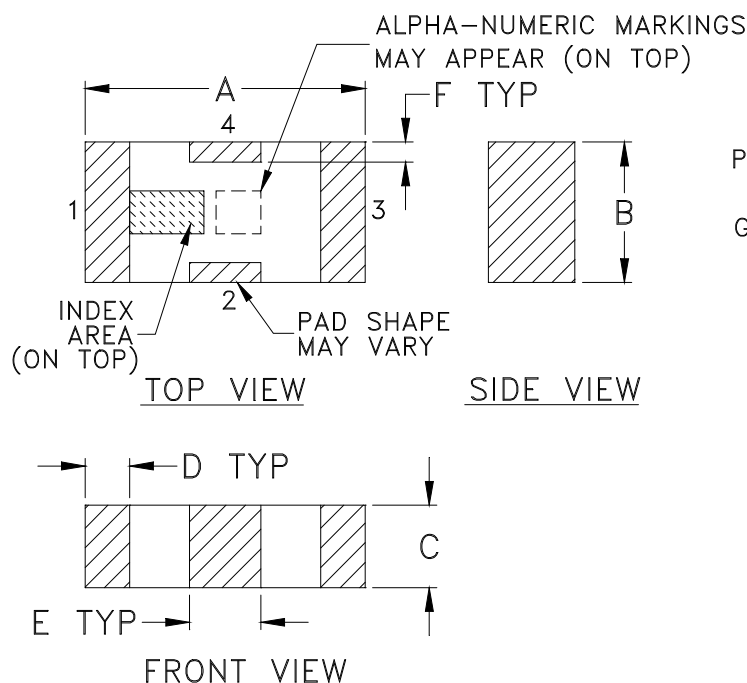
INPUT RETURN LOSS vs. TEMPERATURE



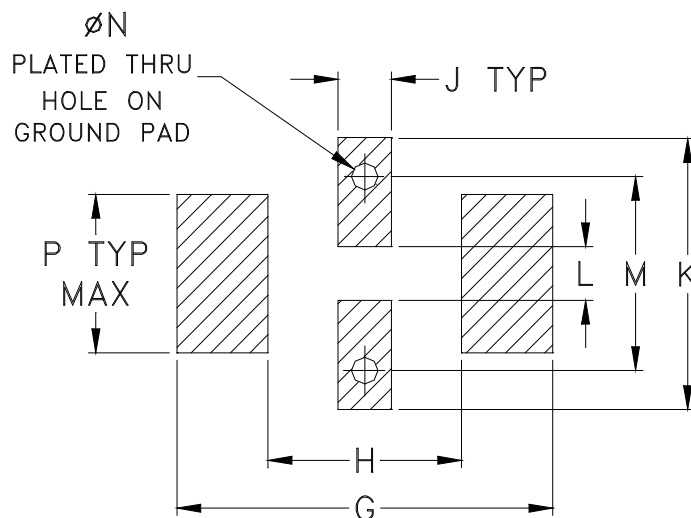
OUTPUT RETURN LOSS vs. TEMPERATURE



Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	N	P	WT. GRAM
FV1206	.126 (3.20)	.063 (1.60)	.037 (0.94)	.020 (0.51)	.032 (0.81)	.009 (0.23)	.169 (4.29)	.087 (2.21)	.024 (0.61)	.122 (3.10)	.024 (0.61)	.087 (2.21)	.012 (0.30)	.071 (1.80)	.020

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish: **as shown below or indicated on Data Sheet.**
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F71

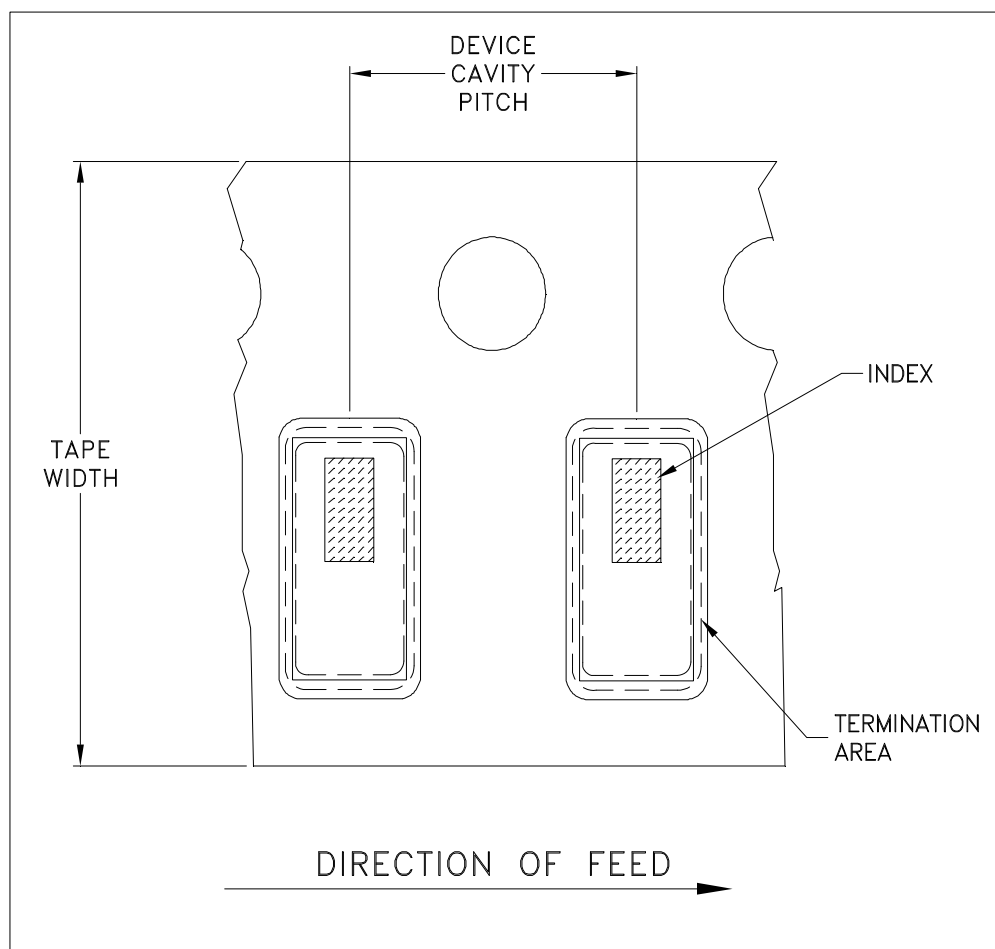


ILLUSTRATION 1

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	3000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



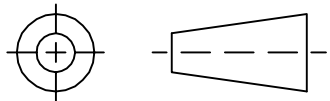
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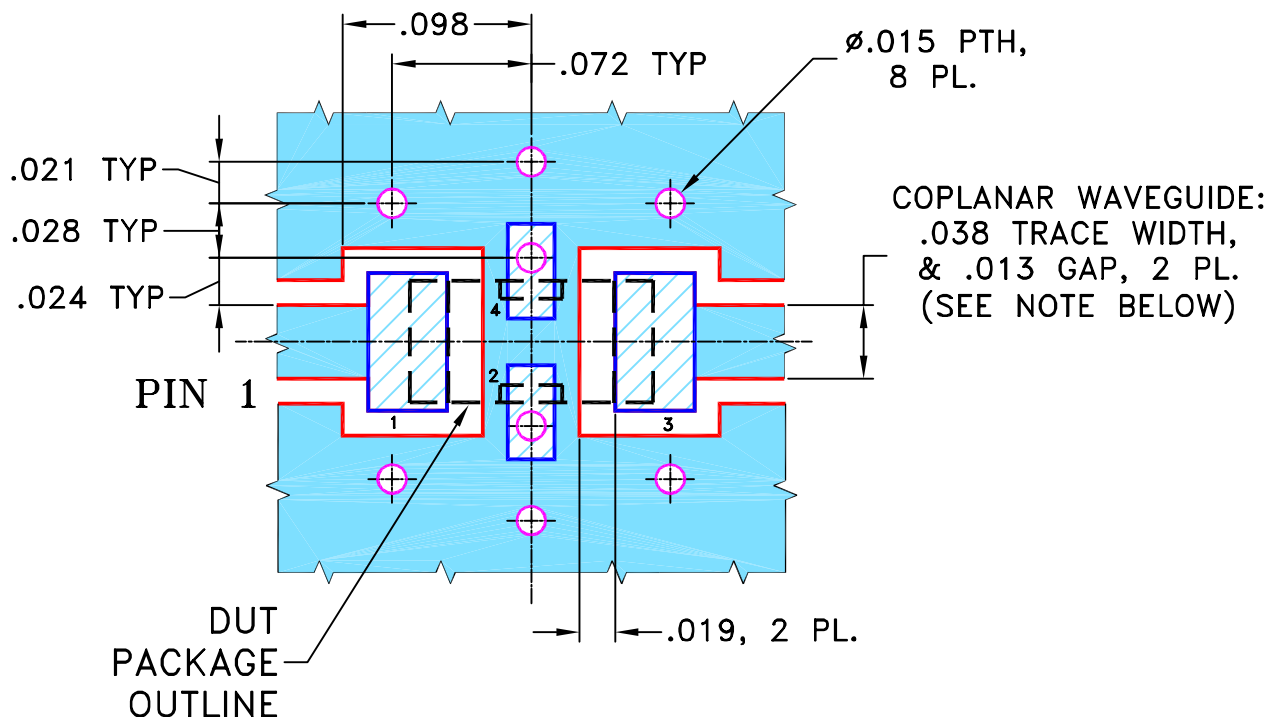
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M88634	NEW RELEASE	08/28/03	GF	ABD
A	M102713	ADDED "...WITH SMOBC"	01/17/06	MMG	IL

SUGGESTED MOUNTING CONFIGURATION
FOR FV1206 CASE STYLE, "nx" PIN CONNECTION

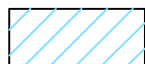


NOTES: 1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH THICKNESS .020" $\pm$.0015".
 COPPER: 1/2 OZ. EACH SIDE.
 FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC
 (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:

2 PL DECIMALS $\pm$ 3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$

DRAWN

GF

08/27/03

CHECKED

AV

08/28/03

APPROVED

ABD

08/28/03



Mini-Circuits®

13 Neptune Avenue
 Brooklyn NY 11235

PL, nx, FV1206, LFCN/HFCN, TB-270

SIZE

A

CODE IDENT

15542

DRAWING NO:

98-PL-137

REV:

A

FILE:

98PL137

SCALE:

10:1

SHEET:

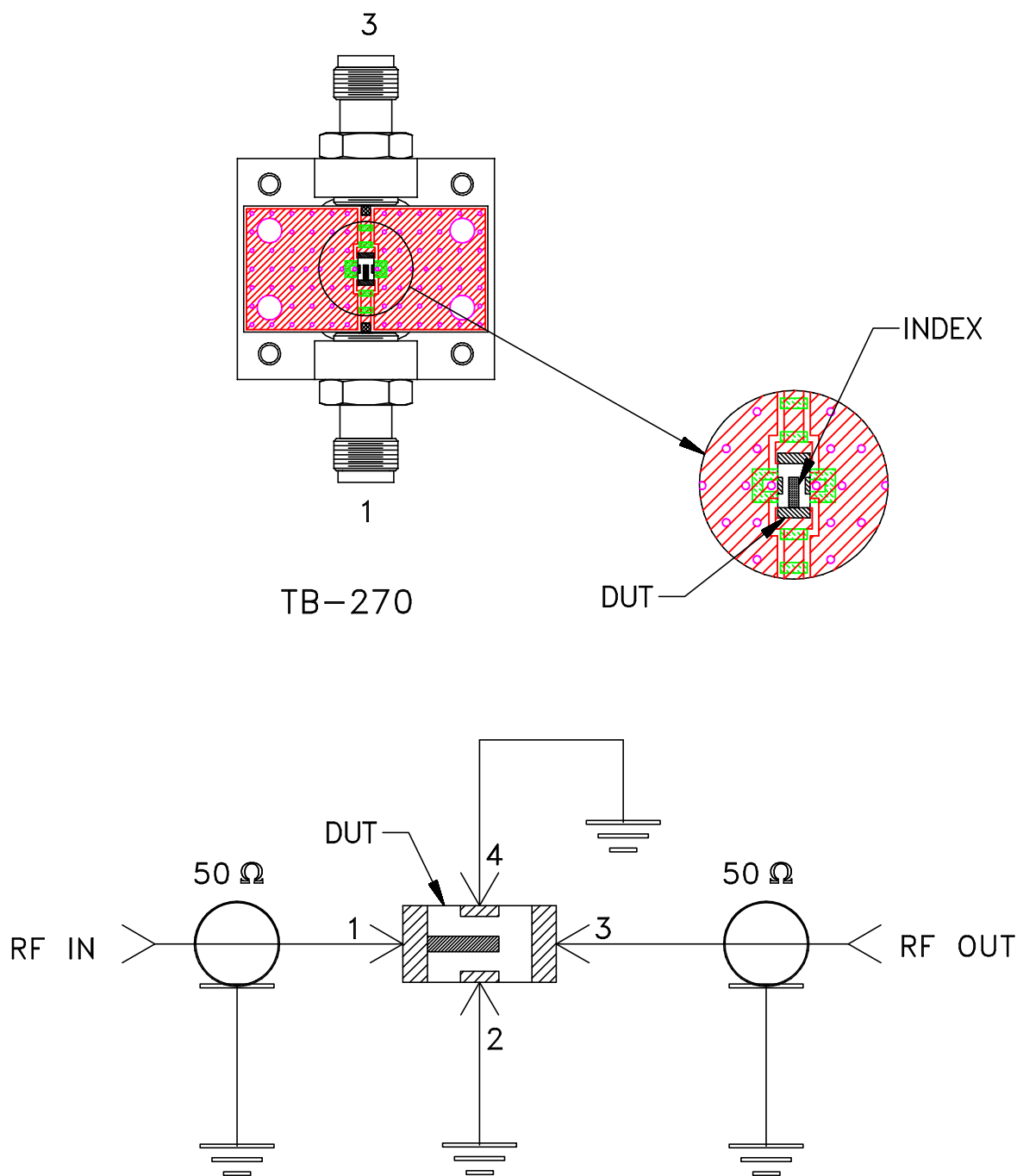
1 OF 1

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ASHEETA1.DWG REV:A DATE:01/12/95

Evaluation Board and Circuit



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: ROGERS RO4350 or equivalent,
Dielectric Constant=3.5, Thickness=.020 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A